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Understanding [Embedded - Microprocessors](#)

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of [Embedded - Microprocessors](#)

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details

Product Status	Obsolete
Core Processor	MPC8xx
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	66MHz
Co-Processors/DSP	Communications; CPM
RAM Controllers	DRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10Mbps (4), 10/100Mbps (1)
SATA	-
USB	-
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	-
Package / Case	357-BBGA
Supplier Device Package	357-PBGA (25x25)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mpc862tvr66b

- The MPC862/857T/857DSL provides enhanced ATM functionality over that of the MPC860SAR. The MPC862/857T/857DSL adds major new features available in “enhanced SAR” (ESAR) mode, including the following:
 - Improved operation, administration and maintenance (OAM) support
 - OAM performance monitoring (PM) support
 - Multiple APC priority levels available to support a range of traffic pace requirements
 - ATM port-to-port switching capability without the need for RAM-based microcode
 - Simultaneous MII (10/100Base-T) and UTOPIA (half-duplex) capability
 - Optional statistical cell counters per PHY
 - UTOPIA level 2 compliant interface with added FIFO buffering to reduce the total cell transmission time. (The earlier UTOPIA level 1 specification is also supported.)
 - Multi-PHY support on the MPC857T
 - Four PHY support on the MPC857DSL
 - Parameter RAM for both SPI and I²C can be relocated without RAM-based microcode
 - Supports full-duplex UTOPIA both master (ATM side) and slave (PHY side) operation using a “split” bus
 - AAL2/VBR functionality is ROM-resident
- Up to 32-bit data bus (dynamic bus sizing for 8, 16, and 32 bits)
- 32 address lines
- Memory controller (eight banks)
 - Contains complete dynamic RAM (DRAM) controller
 - Each bank can be a chip select or $\overline{\text{RAS}}$ to support a DRAM bank
 - Up to 30 wait states programmable per memory bank
 - Glueless interface to Page mode/EDO/SDRAM, SRAM, EPROMs, flash EPROMs, and other memory devices.
 - DRAM controller programmable to support most size and speed memory interfaces
 - Four $\overline{\text{CAS}}$ lines, four $\overline{\text{WE}}$ lines, one $\overline{\text{OE}}$ line
 - Boot chip-select available at reset (options for 8-, 16-, or 32-bit memory)
 - Variable block sizes (32 Kbyte–256 Mbyte)
 - Selectable write protection
 - On-chip bus arbitration logic
- General-purpose timers
 - Four 16-bit timers cascadable to be two 32-bit timers
 - Gate mode can enable/disable counting
 - Interrupt can be masked on reference match and event capture
- Fast Ethernet controller (FEC)
 - Simultaneous MII (10/100Base-T) and UTOPIA operation when using the UTOPIA multiplexed bus.

Features

- Sleep—All units disabled except RTC, PIT, time base, and decremter with PLL active for fast wake up
- Deep sleep—All units disabled including PLL except RTC, PIT, time base, and decremter.
- Power down mode— All units powered down except PLL, RTC, PIT, time base and decremter
- Debug interface
 - Eight comparators: four operate on instruction address, two operate on data address, and two operate on data
 - Supports conditions: = ≠ < >
 - Each watchpoint can generate a break point internally
- 3.3 V operation with 5-V TTL compatibility except EXTAL and EXTCLK
- 357-pin plastic ball grid array (PBGA) package
- Operation up to 100MHz

The MPC862/857T/857DSL is comprised of three modules that each use the 32-bit internal bus: the MPC8xx core, the system integration unit (SIU), and the communication processor module (CPM). The MPC862P/862T block diagram is shown in [Figure 1](#). The MPC857T/857DSL block diagram is shown in [Figure 2](#).

Table 5. DC Electrical Specifications (continued)

Characteristic	Symbol	Min	Max	Unit
Output Low Voltage IOL = 2.0 mA (CLKOUT) IOL = 3.2 mA ³ IOL = 5.3 mA ⁴ IOL = 7.0 mA (TXD1/PA14, TXD2/PA12) IOL = 8.9 mA (\overline{TS} , \overline{TA} , \overline{TEA} , \overline{BI} , \overline{BB} , \overline{HRESET} , \overline{SRESET})	VOL	—	0.5	V

¹ $V_{IL}(\text{max})$ for the I²C interface is 0.8 V rather than the 1.5 V as specified in the I²C standard.

² Input capacitance is periodically sampled.

³ A(0:31), $\overline{TSI0}/\overline{REG}$, $\overline{TSI1}$, D(0:31), DP(0:3)/ \overline{IRQ} (3:6), $\overline{RD}/\overline{WR}$, \overline{BURST} , $\overline{RSV}/\overline{IRQ2}$, $\overline{IP_B}(0:1)/\overline{IWP}(0:1)/\overline{VFLS}(0:1)$, $\overline{IP_B2}/\overline{IOIS16_B}/\overline{AT2}$, $\overline{IP_B3}/\overline{IWP2}/\overline{VF2}$, $\overline{IP_B4}/\overline{LWP0}/\overline{VF0}$, $\overline{IP_B5}/\overline{LWP1}/\overline{VF1}$, $\overline{IP_B6}/\overline{DSDI}/\overline{AT0}$, $\overline{IP_B7}/\overline{PTR}/\overline{AT3}$, $\overline{RXD1}/\overline{PA15}$, $\overline{RXD2}/\overline{PA13}$, $\overline{L1TXDB}/\overline{PA11}$, $\overline{L1RXDB}/\overline{PA10}$, $\overline{L1TXDA}/\overline{PA9}$, $\overline{L1RXDA}/\overline{PA8}$, $\overline{TIN1}/\overline{L1RCLKA}/\overline{BRGO1}/\overline{CLK1}/\overline{PA7}$, $\overline{BRGCLK1}/\overline{TOUT1}/\overline{CLK2}/\overline{PA6}$, $\overline{TIN2}/\overline{L1TCLKA}/\overline{BRGO2}/\overline{CLK3}/\overline{PA5}$, $\overline{TOUT2}/\overline{CLK4}/\overline{PA4}$, $\overline{TIN3}/\overline{BRGO3}/\overline{CLK5}/\overline{PA3}$, $\overline{BRGCLK2}/\overline{L1RCLKB}/\overline{TOUT3}/\overline{CLK6}/\overline{PA2}$, $\overline{TIN4}/\overline{BRGO4}/\overline{CLK7}/\overline{PA1}$, $\overline{L1TCLKB}/\overline{TOUT4}/\overline{CLK8}/\overline{PA0}$, $\overline{REJECT1}/\overline{SPISEL}/\overline{PB31}$, $\overline{SPICLK}/\overline{PB30}$, $\overline{SPIMOSI}/\overline{PB29}$, $\overline{BRGO4}/\overline{SPIMISO}/\overline{PB28}$, $\overline{BRGO1}/\overline{I2CSDA}/\overline{PB27}$, $\overline{BRGO2}/\overline{I2CSCL}/\overline{PB26}$, $\overline{SMTXD1}/\overline{PB25}$, $\overline{SMRXD1}/\overline{PB24}$, $\overline{SMSYN1}/\overline{SDACK1}/\overline{PB23}$, $\overline{SMSYN2}/\overline{SDACK2}/\overline{PB22}$, $\overline{SMTXD2}/\overline{L1CLKOB}/\overline{PB21}$, $\overline{SMRXD2}/\overline{L1CLKOA}/\overline{PB20}$, $\overline{L1ST1}/\overline{RTS1}/\overline{PB19}$, $\overline{L1ST2}/\overline{RTS2}/\overline{PB18}$, $\overline{L1ST3}/\overline{L1RQB}/\overline{PB17}$, $\overline{L1ST4}/\overline{L1RQA}/\overline{PB16}$, $\overline{BRGO3}/\overline{PB15}$, $\overline{RSTR1}/\overline{PB14}$, $\overline{L1ST1}/\overline{RTS1}/\overline{DREQ0}/\overline{PC15}$, $\overline{L1ST2}/\overline{RTS2}/\overline{DREQ1}/\overline{PC14}$, $\overline{L1ST3}/\overline{L1RQB}/\overline{PC13}$, $\overline{L1ST4}/\overline{L1RQA}/\overline{PC12}$, $\overline{CTS1}/\overline{PC11}$, $\overline{TGATE1}/\overline{CD1}/\overline{PC10}$, $\overline{CTS2}/\overline{PC9}$, $\overline{TGATE2}/\overline{CD2}/\overline{PC8}$, $\overline{CTS3}/\overline{SDACK2}/\overline{L1TSYNCB}/\overline{PC7}$, $\overline{CD3}/\overline{L1RSYNCB}/\overline{PC6}$, $\overline{CTS4}/\overline{SDACK1}/\overline{L1TSYNCA}/\overline{PC5}$, $\overline{CD4}/\overline{L1RSYNCA}/\overline{PC4}$, $\overline{PD15}/\overline{L1TSYNCA}$, $\overline{PD14}/\overline{L1RSYNCA}$, $\overline{PD13}/\overline{L1TSYNCB}$, $\overline{PD12}/\overline{L1RSYNCB}$, $\overline{PD11}/\overline{RXD3}$, $\overline{PD10}/\overline{TXD3}$, $\overline{PD9}/\overline{RXD4}$, $\overline{PD8}/\overline{TXD4}$, $\overline{PD5}/\overline{REJECT2}$, $\overline{PD6}/\overline{RTS4}$, $\overline{PD7}/\overline{RTS3}$, $\overline{PD4}/\overline{REJECT3}$, $\overline{PD3}$, $\overline{MII_MDC}$, $\overline{MII_TX_ER}$, $\overline{MII_EN}$, $\overline{MII_MDIO}$, $\overline{MII_TXD}[0:3]$.

⁴ $\overline{BDIP}/\overline{GPL_B}(5)$, \overline{BR} , \overline{BG} , $\overline{FRZ}/\overline{IRQ6}$, $\overline{CS}(0:5)$, $\overline{CS}(6)/\overline{CE}(1)_B$, $\overline{CS}(7)/\overline{CE}(2)_B$, $\overline{WE0}/\overline{BS_B0}/\overline{IORD}$, $\overline{WE1}/\overline{BS_B1}/\overline{IOWR}$, $\overline{WE2}/\overline{BS_B2}/\overline{PCOE}$, $\overline{WE3}/\overline{BS_B3}/\overline{PCWE}$, $\overline{BS_A}(0:3)$, $\overline{GPL_A0}/\overline{GPL_B0}$, $\overline{OE}/\overline{GPL_A1}/\overline{GPL_B1}$, $\overline{GPL_A}(2:3)/\overline{GPL_B}(2:3)/\overline{CS}(2:3)$, $\overline{UPWAITA}/\overline{GPL_A4}$, $\overline{UPWAITB}/\overline{GPL_B4}$, $\overline{GPL_A5}$, $\overline{ALE_A}$, $\overline{CE1_A}$, $\overline{CE2_A}$, $\overline{ALE_B}/\overline{DSCK}/\overline{AT1}$, $\overline{OP}(0:1)$, $\overline{OP2}/\overline{MODCK1}/\overline{STS}$, $\overline{OP3}/\overline{MODCK2}/\overline{DSDO}$, $\overline{BADDR}(28:30)$.

7 Thermal Calculation and Measurement

For the following discussions, $P_D = (V_{DD} \times I_{DD}) + P_{I/O}$, where $P_{I/O}$ is the power dissipation of the I/O drivers.

7.1 Estimation with Junction-to-Ambient Thermal Resistance

An estimation of the chip junction temperature, T_J , in °C can be obtained from the equation:

$$T_J = T_A + (R_{\theta JA} \times P_D)$$

where:

T_A = ambient temperature (°C)

$R_{\theta JA}$ = package junction-to-ambient thermal resistance (°C/W)

P_D = power dissipation in package

The junction-to-ambient thermal resistance is an industry standard value which provides a quick and easy estimation of thermal performance. However, the answer is only an estimate; test cases have demonstrated that errors of a factor of two (in the quantity $T_J - T_A$) are possible.

Table 7. Bus Operation Timings (continued)

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
B30c	$\overline{WE}(0:3)$ negated to A(0:31), BADDR(28:30) invalid GPCM write access, TRLX = 0, CSNT = 1. \overline{CS} negated to A(0:31) invalid GPCM write access, TRLX = 0, CSNT = 1 ACS = 10, ACS == 11, EBDF = 1 (MIN = 0.375 x B1 - 3.00)	8.40	—	6.40	—	4.50	—	2.70	—	ns
B30d	$\overline{WE}(0:3)$ negated to A(0:31), BADDR(28:30) invalid GPCM write access TRLX = 1, CSNT = 1, \overline{CS} negated to A(0:31) invalid GPCM write access TRLX = 1, CSNT = 1, ACS = 10 or 11, EBDF = 1	38.67	—	31.38	—	24.50	—	17.83	—	ns
B31	CLKOUT falling edge to \overline{CS} valid - as requested by control bit CST4 in the corresponding word in the UPM (MAX = 0.00 X B1 + 6.00)	1.50	6.00	1.50	6.00	1.50	6.00	1.50	6.00	ns
B31a	CLKOUT falling edge to \overline{CS} valid - as requested by control bit CST1 in the corresponding word in the UPM (MAX = 0.25 x B1 + 6.80)	7.60	14.30	6.30	13.00	5.00	11.80	3.80	10.50	ns
B31b	CLKOUT rising edge to \overline{CS} valid - as requested by control bit CST2 in the corresponding word in the UPM (MAX = 0.00 x B1 + 8.00)	1.50	8.00	1.50	8.00	1.50	8.00	1.50	8.00	ns
B31c	CLKOUT rising edge to \overline{CS} valid- as requested by control bit CST3 in the corresponding word in the UPM (MAX = 0.25 x B1 + 6.30)	7.60	13.80	6.30	12.50	5.00	11.30	3.80	10.00	ns
B31d	CLKOUT falling edge to \overline{CS} valid, as requested by control bit CST1 in the corresponding word in the UPM EBDF = 1 (MAX = 0.375 x B1 + 6.6)	9.40	18.00	7.60	16.00	13.30	14.10	11.30	12.30	ns
B32	CLKOUT falling edge to \overline{BS} valid- as requested by control bit BST4 in the corresponding word in the UPM (MAX = 0.00 x B1 + 6.00)	1.50	6.00	1.50	6.00	1.50	6.00	1.50	6.00	ns
B32a	CLKOUT falling edge to \overline{BS} valid - as requested by control bit BST1 in the corresponding word in the UPM, EBDF = 0 (MAX = 0.25 x B1 + 6.80)	7.60	14.30	6.30	13.00	5.00	11.80	3.80	10.50	ns
B32b	CLKOUT rising edge to \overline{BS} valid - as requested by control bit BST2 in the corresponding word in the UPM (MAX = 0.00 x B1 + 8.00)	1.50	8.00	1.50	8.00	1.50	8.00	1.50	8.00	ns

Table 7. Bus Operation Timings (continued)

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
B32c	CLKOUT rising edge to \overline{BS} valid - as requested by control bit BST3 in the corresponding word in the UPM (MAX = $0.25 \times B1 + 6.80$)	7.60	14.30	6.30	13.00	5.00	11.80	3.80	10.50	ns
B32d	CLKOUT falling edge to \overline{BS} valid- as requested by control bit BST1 in the corresponding word in the UPM, EBDf = 1 (MAX = $0.375 \times B1 + 6.60$)	9.40	18.00	7.60	16.00	13.30	14.10	11.30	12.30	ns
B33	CLKOUT falling edge to \overline{GPL} valid - as requested by control bit GxT4 in the corresponding word in the UPM (MAX = $0.00 \times B1 + 6.00$)	1.50	6.00	1.50	6.00	1.50	6.00	1.50	6.00	ns
B33a	CLKOUT rising edge to \overline{GPL} Valid - as requested by control bit GxT3 in the corresponding word in the UPM (MAX = $0.25 \times B1 + 6.80$)	7.60	14.30	6.30	13.00	5.00	11.80	3.80	10.50	ns
B34	A(0:31), BADDR(28:30), and D(0:31) to \overline{CS} valid - as requested by control bit CST4 in the corresponding word in the UPM (MIN = $0.25 \times B1 - 2.00$)	5.60	—	4.30	—	3.00	—	1.80	—	ns
B34a	A(0:31), BADDR(28:30), and D(0:31) to \overline{CS} valid - as requested by control bit CST1 in the corresponding word in the UPM (MIN = $0.50 \times B1 - 2.00$)	13.20	—	10.50	—	8.00	—	5.60	—	ns
B34b	A(0:31), BADDR(28:30), and D(0:31) to \overline{CS} valid - as requested by CST2 in the corresponding word in UPM (MIN = $0.75 \times B1 - 2.00$)	20.70	—	16.70	—	13.00	—	9.40	—	ns
B35	A(0:31), BADDR(28:30) to \overline{CS} valid - as requested by control bit BST4 in the corresponding word in the UPM (MIN = $0.25 \times B1 - 2.00$)	5.60	—	4.30	—	3.00	—	1.80	—	ns
B35a	A(0:31), BADDR(28:30), and D(0:31) to \overline{BS} valid - As Requested by BST1 in the corresponding word in the UPM (MIN = $0.50 \times B1 - 2.00$)	13.20	—	10.50	—	8.00	—	5.60	—	ns
B35b	A(0:31), BADDR(28:30), and D(0:31) to \overline{BS} valid - as requested by control bit BST2 in the corresponding word in the UPM (MIN = $0.75 \times B1 - 2.00$)	20.70	—	16.70	—	13.00	—	9.40	—	ns
B36	A(0:31), BADDR(28:30), and D(0:31) to \overline{GPL} valid as requested by control bit GxT4 in the corresponding word in the UPM (MIN = $0.25 \times B1 - 2.00$)	5.60	—	4.30	—	3.00	—	1.80	—	ns

Table 7. Bus Operation Timings (continued)

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
B37	UPWAIT valid to CLKOUT falling edge ¹² (MIN = 0.00 x B1 + 6.00)	6.00	—	6.00	—	6.00	—	6.00	—	ns
B38	CLKOUT falling edge to UPGATE valid ¹² (MIN = 0.00 x B1 + 1.00)	1.00	—	1.00	—	1.00	—	1.00	—	ns
B39	\overline{AS} valid to CLKOUT rising edge ¹³ (MIN = 0.00 x B1 + 7.00)	7.00	—	7.00	—	7.00	—	7.00	—	ns
B40	A(0:31), TSIZ(0:1), RD/WR, BURST, valid to CLKOUT rising edge (MIN = 0.00 x B1 + 7.00)	7.00	—	7.00	—	7.00	—	7.00	—	ns
B41	\overline{TS} valid to CLKOUT rising edge (setup time) (MIN = 0.00 x B1 + 7.00)	7.00	—	7.00	—	7.00	—	7.00	—	ns
B42	CLKOUT rising edge to \overline{TS} valid (hold time) (MIN = 0.00 x B1 + 2.00)	2.00	—	2.00	—	2.00	—	2.00	—	ns
B43	\overline{AS} negation to memory controller signals negation (MAX = TBD)	—	TBD	—	TBD	—	TBD	—	TBD	ns

¹ Phase and frequency jitter performance results are only valid if the input jitter is less than the prescribed value.

² If the rate of change of the frequency of EXTAL is slow (i.e. it does not jump between the minimum and maximum values in one cycle) or the frequency of the jitter is fast (i.e., it does not stay at an extreme value for a long time) then the maximum allowed jitter on EXTAL can be up to 2%.

³ The timings specified in B4 and B5 are based on full strength clock.

⁴ The timing for \overline{BR} output is relevant when the MPC862/857T/857DSL is selected to work with external bus arbiter. The timing for \overline{BG} output is relevant when the MPC862/857T/857DSL is selected to work with internal bus arbiter.

⁵ For part speeds above 50MHz, use 9.80ns for B11a.

⁶ The timing required for \overline{BR} input is relevant when the MPC862/857T/857DSL is selected to work with internal bus arbiter. The timing for \overline{BG} input is relevant when the MPC862/857T/857DSL is selected to work with external bus arbiter.

⁷ For part speeds above 50MHz, use 2ns for B17.

⁸ The D(0:31) and DP(0:3) input timings B18 and B19 refer to the rising edge of the CLKOUT in which the \overline{TA} input signal is asserted.

⁹ For part speeds above 50MHz, use 2ns for B19.

¹⁰ The D(0:31) and DP(0:3) input timings B20 and B21 refer to the falling edge of the CLKOUT. This timing is valid only for read accesses controlled by chip-selects under control of the UPM in the memory controller, for data beats where DLT3 = 1 in the UPM RAM words. (This is only the case where data is latched on the falling edge of CLKOUT.)

¹¹ The timing B30 refers to \overline{CS} when ACS = 00 and to $\overline{WE}(0:3)$ when CSNT = 0.

¹² The signal UPGATE is considered asynchronous to the CLKOUT and synchronized internally. The timings specified in B37 and B38 are specified to enable the freeze of the UPM output signals as described in Figure 19.

¹³ The \overline{AS} signal is considered asynchronous to the CLKOUT. The timing B39 is specified in order to allow the behavior specified in Figure 22.

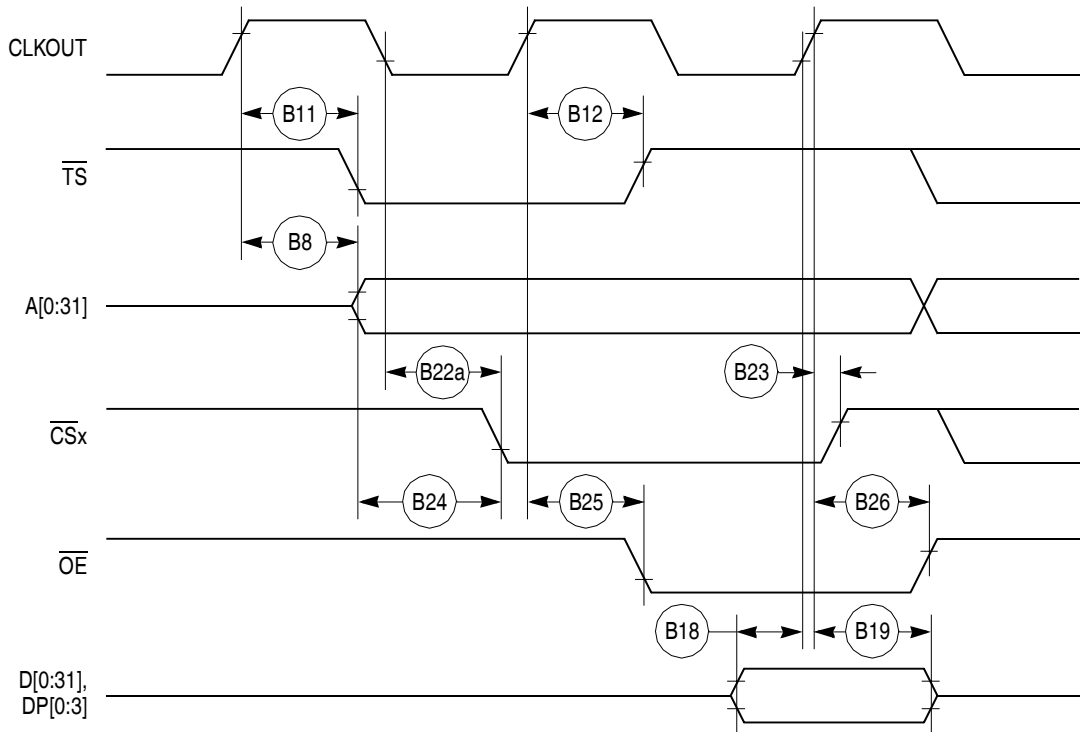


Figure 12. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 10)

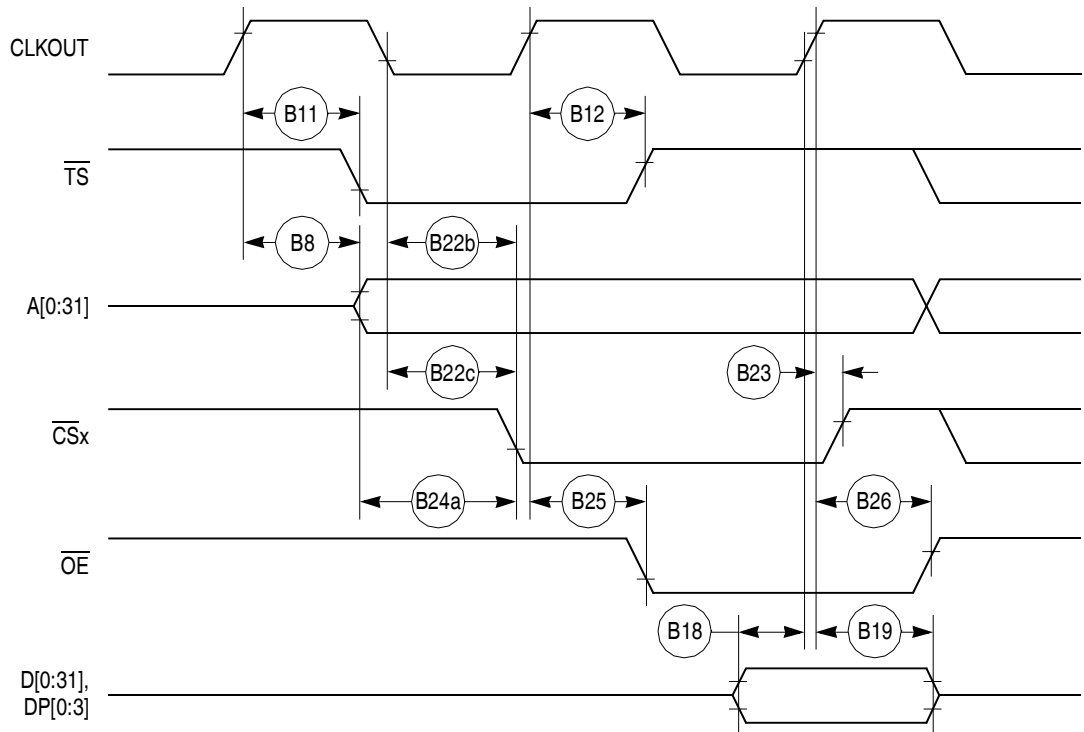


Figure 13. External Bus Read Timing (GPCM Controlled—TRLX = 0, ACS = 11)

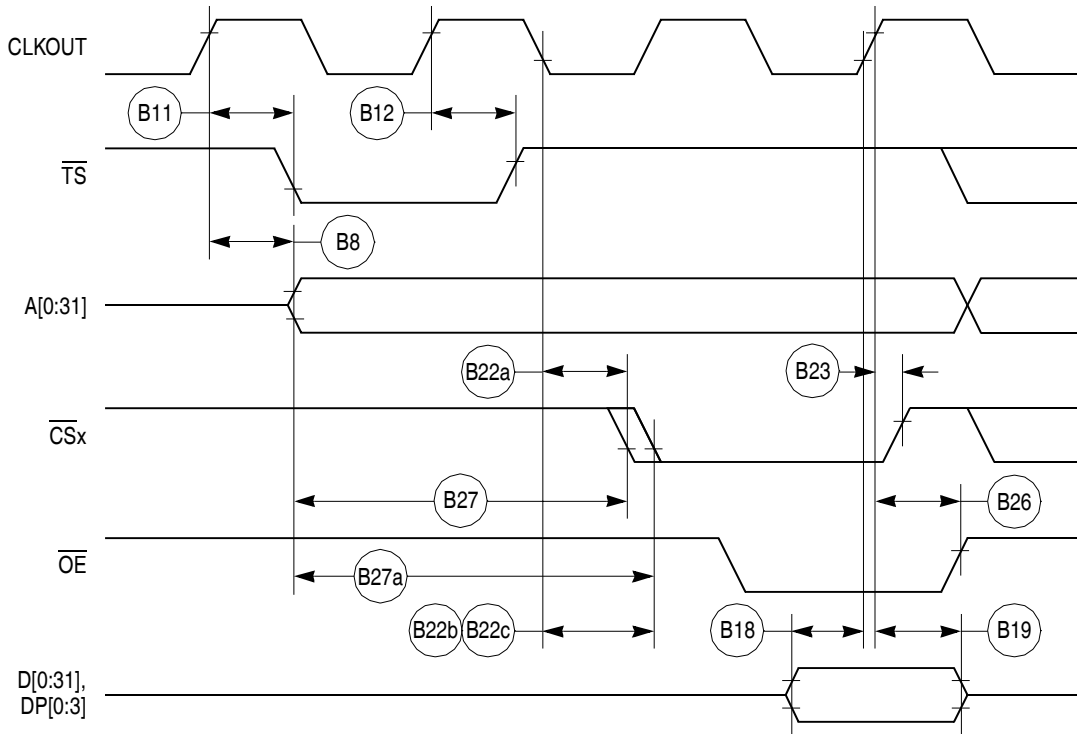


Figure 14. External Bus Read Timing (GPCM Controlled—TRLX = 1, ACS = 10, ACS = 11)

Figure 15 through Figure 17 provide the timing for the external bus write controlled by various GPCM factors.

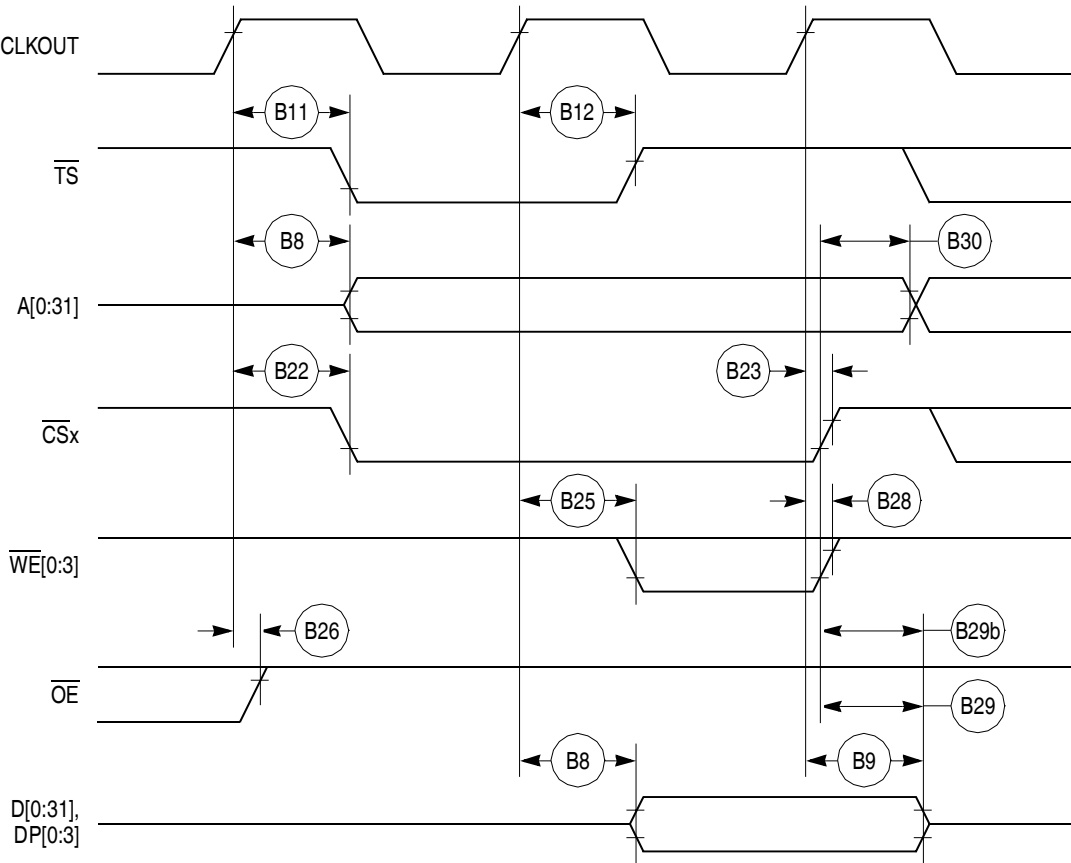
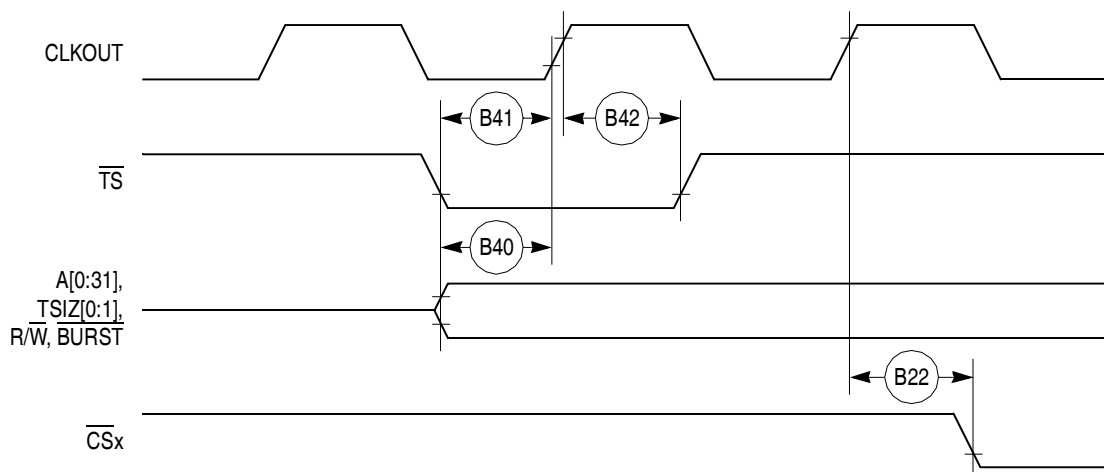


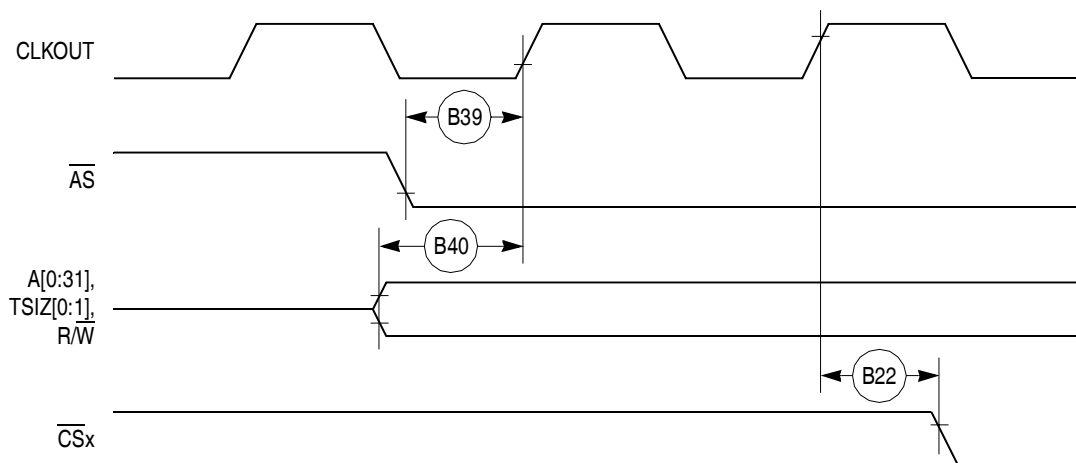
Figure 15. External Bus Write Timing (GPCM Controlled—TRLX = 0,1 CSNT = 0)

Figure 21 provides the timing for the synchronous external master access controlled by the GPCM.



**Figure 21. Synchronous External Master Access Timing
(GPCM Handled ACS = 00)**

Figure 22 provides the timing for the asynchronous external master memory access controlled by the GPCM.



**Figure 22. Asynchronous External Master Memory Access Timing
(GPCM Controlled—ACS = 00)**

Figure 23 provides the timing for the asynchronous external master control signals negation.

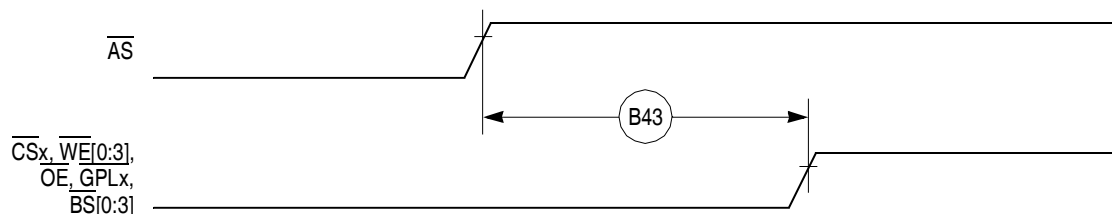


Figure 23. Asynchronous External Master—Control Signals Negation Timing

Table 10 shows the PCMCIA port timing for the MPC862/857T/857DSL.

Table 10. PCMCIA Port Timing

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
P57	CLKOUT to OPx Valid (MAX = $0.00 \times B1 + 19.00$)	—	19.00	—	19.00	—	19.00	—	19.00	ns
P58	$\overline{\text{HRESET}}$ negated to OPx drive ¹ (MIN = $0.75 \times B1 + 3.00$)	25.70	—	21.70	—	18.00	—	14.40	—	ns
P59	IP_Xx valid to CLKOUT rising edge (MIN = $0.00 \times B1 + 5.00$)	5.00	—	5.00	—	5.00	—	5.00	—	ns
P60	CLKOUT rising edge to IP_Xx invalid (MIN = $0.00 \times B1 + 1.00$)	1.00	—	1.00	—	1.00	—	1.00	—	ns

¹ OP2 and OP3 only.

Figure 29 provides the PCMCIA output port timing for the MPC862/857T/857DSL.

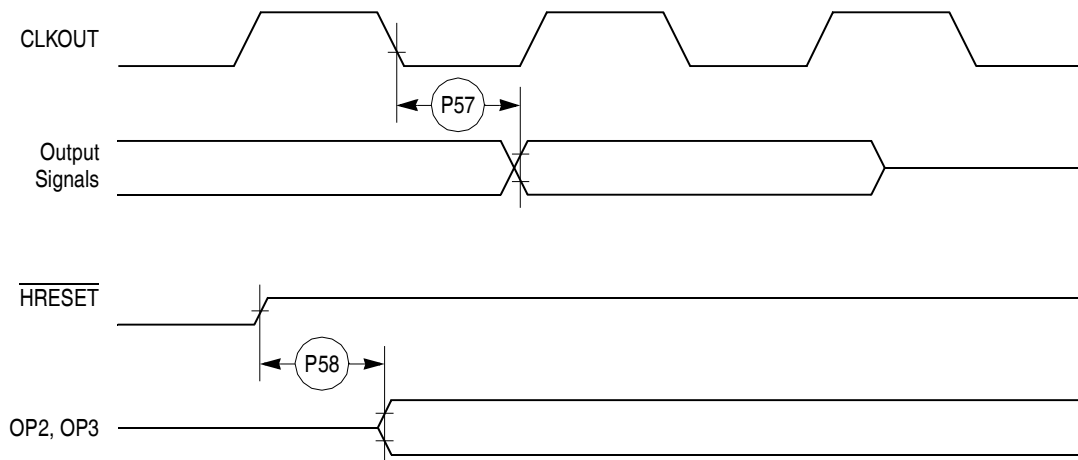


Figure 29. PCMCIA Output Port Timing

Figure 30 provides the PCMCIA output port timing for the MPC862/857T/857DSL.

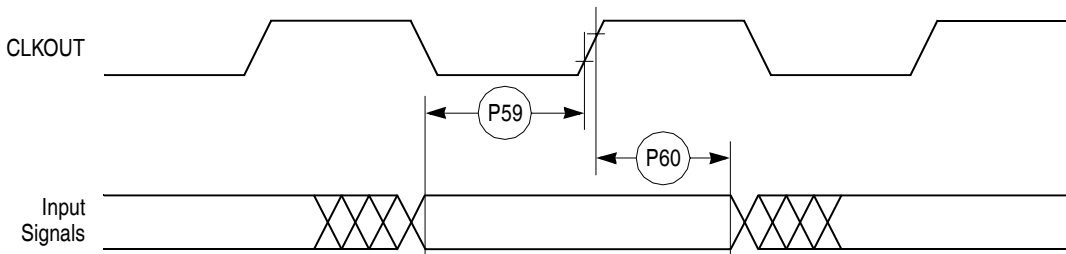


Figure 30. PCMCIA Input Port Timing

Table 12 shows the reset timing for the MPC862/857T/857DSL.

Table 12. Reset Timing

Num	Characteristic	33 MHz		40 MHz		50 MHz		66 MHz		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
R69	CLKOUT to $\overline{\text{HRESET}}$ high impedance (MAX = $0.00 \times B1 + 20.00$)	—	20.00	—	20.00	—	20.00	—	20.00	ns
R70	CLKOUT to $\overline{\text{SRESET}}$ high impedance (MAX = $0.00 \times B1 + 20.00$)	—	20.00	—	20.00	—	20.00	—	20.00	ns
R71	$\overline{\text{RSTCONF}}$ pulse width (MIN = $17.00 \times B1$)	515.20	—	425.00	—	340.00	—	257.60	—	ns
R72	—	—	—	—	—	—	—	—	—	—
R73	Configuration data to $\overline{\text{HRESET}}$ rising edge set up time (MIN = $15.00 \times B1 + 50.00$)	504.50	—	425.00	—	350.00	—	277.30	—	ns
R74	Configuration data to $\overline{\text{RSTCONF}}$ rising edge set up time (MIN = $0.00 \times B1 + 350.00$)	350.00	—	350.00	—	350.00	—	350.00	—	ns
R75	Configuration data hold time after $\overline{\text{RSTCONF}}$ negation (MIN = $0.00 \times B1 + 0.00$)	0.00	—	0.00	—	0.00	—	0.00	—	ns
R76	Configuration data hold time after $\overline{\text{HRESET}}$ negation (MIN = $0.00 \times B1 + 0.00$)	0.00	—	0.00	—	0.00	—	0.00	—	ns
R77	$\overline{\text{HRESET}}$ and $\overline{\text{RSTCONF}}$ asserted to data out drive (MAX = $0.00 \times B1 + 25.00$)	—	25.00	—	25.00	—	25.00	—	25.00	ns
R78	$\overline{\text{RSTCONF}}$ negated to data out high impedance. (MAX = $0.00 \times B1 + 25.00$)	—	25.00	—	25.00	—	25.00	—	25.00	ns
R79	CLKOUT of last rising edge before chip three-states $\overline{\text{HRESET}}$ to data out high impedance. (MAX = $0.00 \times B1 + 25.00$)	—	25.00	—	25.00	—	25.00	—	25.00	ns
R80	DSDI, DSCK set up (MIN = $3.00 \times B1$)	90.90	—	75.00	—	60.00	—	45.50	—	ns
R81	DSDI, DSCK hold time (MIN = $0.00 \times B1 + 0.00$)	0.00	—	0.00	—	0.00	—	0.00	—	ns
R82	$\overline{\text{SRESET}}$ negated to CLKOUT rising edge for DSDI and DSCK sample (MIN = $8.00 \times B1$)	242.40	—	200.00	—	160.00	—	121.20	—	ns

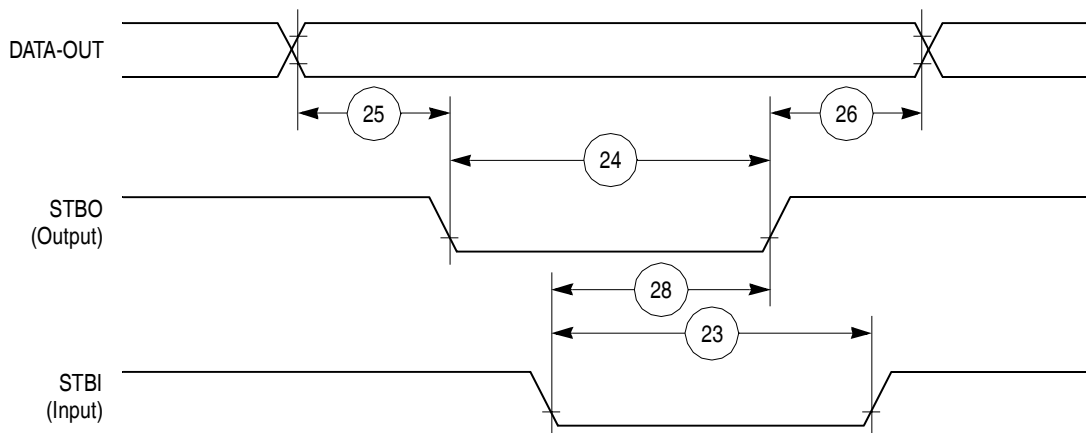


Figure 41. PIP Tx (Interlock Mode) Timing Diagram

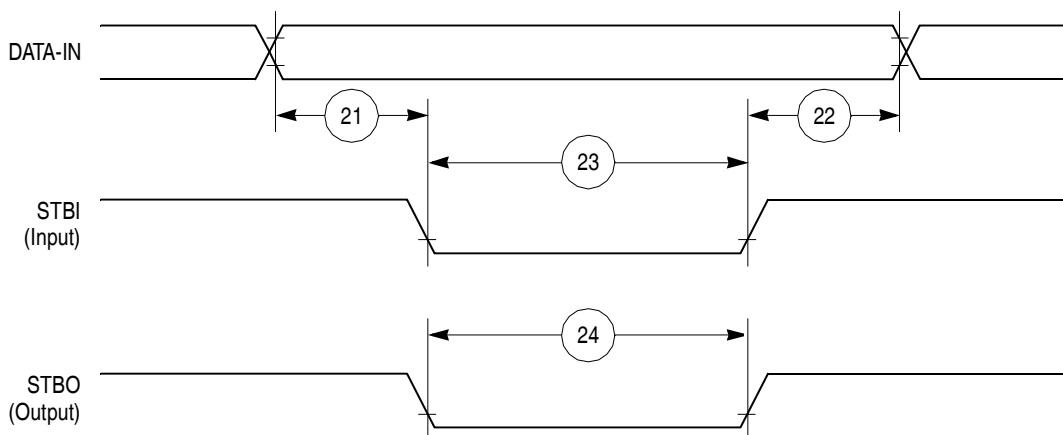


Figure 42. PIP Rx (Pulse Mode) Timing Diagram

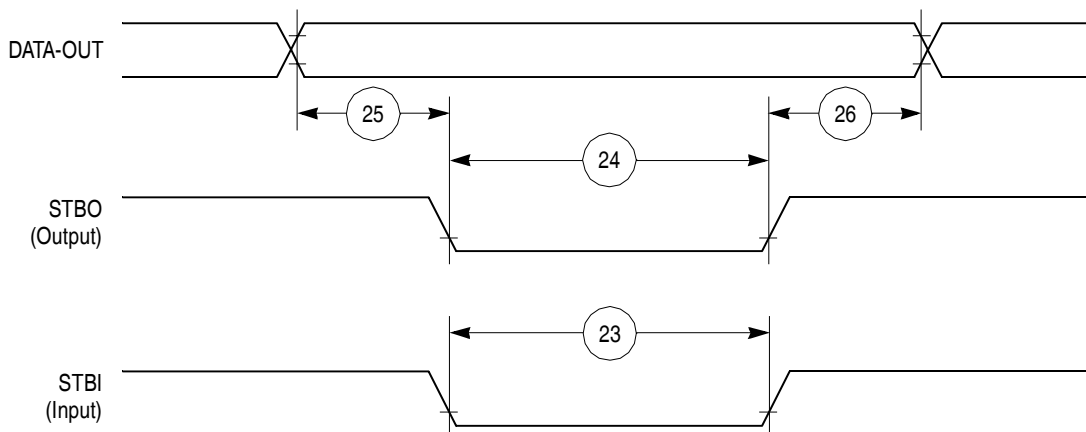


Figure 43. PIP TX (Pulse Mode) Timing Diagram

Table 19. SI Timing (continued)

Num	Characteristic	All Frequencies		Unit
		Min	Max	
83a	L1RCLK, L1TCLK width high (DSC = 1) ³	P + 10	—	ns
84	L1CLK edge to L1CLKO valid (DSC = 1)	—	30.00	ns
85	$\overline{\text{L1RQ}}$ valid before falling edge of L1TSYNC ⁴	1.00	—	L1TCLK
86	L1GR setup time ²	42.00	—	ns
87	L1GR hold time	42.00	—	ns
88	L1CLK edge to L1SYNC valid (FSD = 00) CNT = 0000, BYT = 0, DSC = 0)	—	0.00	ns

¹ The ratio SyncCLK/L1RCLK must be greater than 2.5/1.

² These specs are valid for IDL mode only.

³ Where P = 1/CLKOUT. Thus for a 25-MHz CLKOUT rate, P = 40 ns.

⁴ These strobes and TxD on the first bit of the frame become valid after L1CLK edge or L1SYNC, whichever is later.

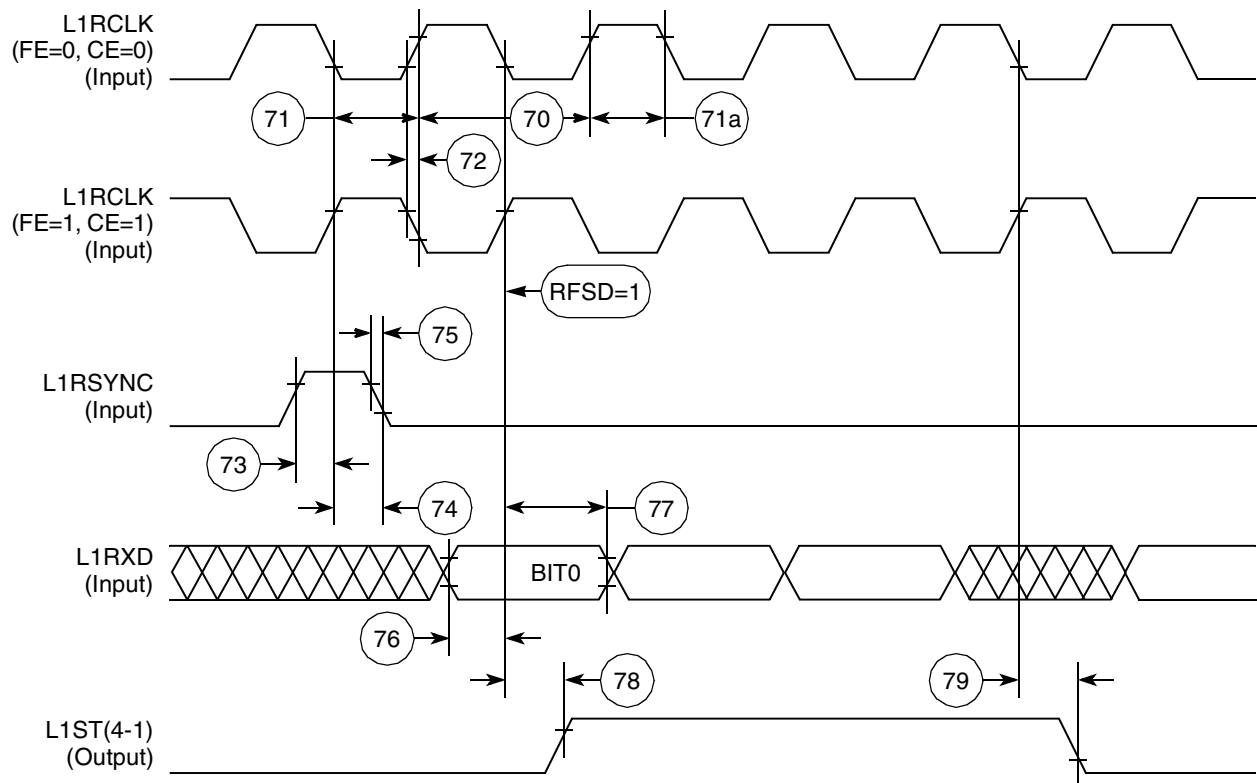


Figure 52. SI Receive Timing Diagram with Normal Clocking (DSC = 0)

Table 22. Ethernet Timing (continued)

Num	Characteristic	All Frequencies		Unit
		Min	Max	
134	TENA inactive delay (from TCLK1 rising edge)	10	50	ns
135	$\overline{\text{RSTRT}}$ active delay (from TCLK1 falling edge)	10	50	ns
136	$\overline{\text{RSTRT}}$ inactive delay (from TCLK1 falling edge)	10	50	ns
137	$\overline{\text{REJECT}}$ width low	1	—	CLK
138	CLKO1 low to $\overline{\text{SDACK}}$ asserted ²	—	20	ns
139	CLKO1 low to $\overline{\text{SDACK}}$ negated ²	—	20	ns

¹ The ratios SyncCLK/RCLK1 and SyncCLK/TCLK1 must be greater or equal to 2/1.

² $\overline{\text{SDACK}}$ is asserted whenever the SDMA writes the incoming frame DA into memory.

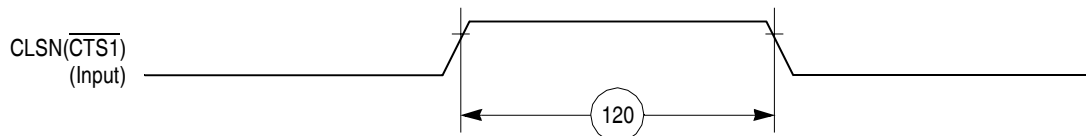


Figure 60. Ethernet Collision Timing Diagram

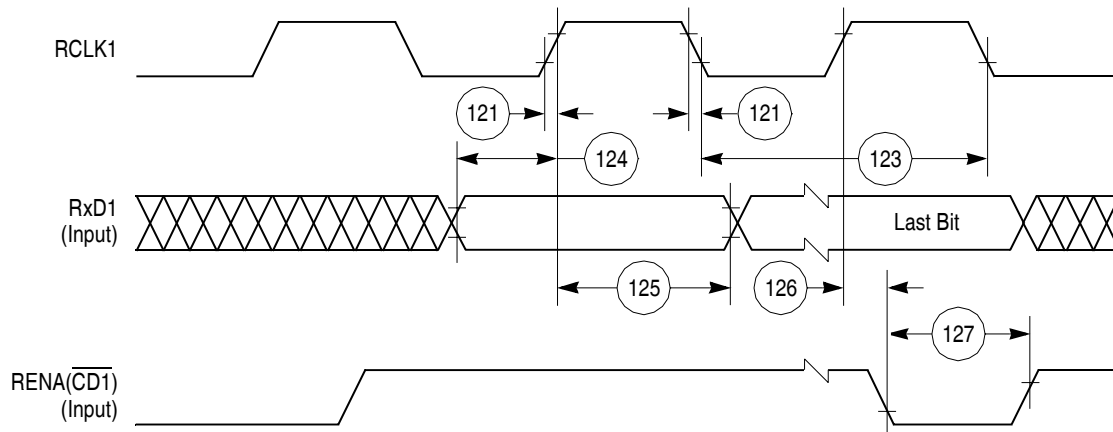


Figure 61. Ethernet Receive Timing Diagram

Figure 70 shows the I²C bus timing.

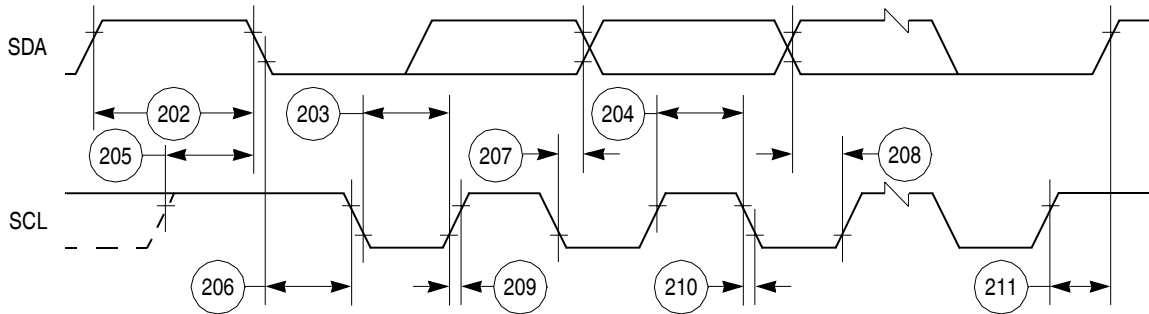


Figure 70. I²C Bus Timing Diagram

12 UTOPIA AC Electrical Specifications

Table 28 shows the AC electrical specifications for the UTOPIA interface.

Table 28. UTOPIA AC Electrical Specifications

Num	Signal Characteristic	Direction	Min	Max	Unit
U1	UtpClk rise/fall time (Internal clock option)	Output		4 ns	ns
	Duty cycle		50	50	%
	Frequency			33	MHz
U1a	UtpClk rise/fall time (external clock option)	Input		4ns	ns
	Duty cycle		40	60	%
	Frequency			33	MHz
U2	$\overline{\text{RxEnb}}$ and $\overline{\text{TxEnb}}$ active delay	Output	2 ns	16 ns	ns
U3	UTPB, SOC, Rxclav and Txclav setup time	Input	4 ns		ns
U4	UTPB, SOC, Rxclav and Txclav hold time	Input	1 ns		ns
U5	UTPB, SOC active delay (and PHREQ and PHSEL active delay in MPHY mode)	Output	2 ns	16 ns	ns

Table 35. Pin Assignments (continued)

Name	Pin Number	Type
PA2 CLK6 <u>TOUT3</u> L1RCLKB	R18	Bidirectional
PA1 CLK7 BRGO4 TIN4	T19	Bidirectional
PA0 CLK8 <u>TOUT4</u> L1TCLKB	U19	Bidirectional
PB31 <u>SPISEL</u> <u>REJECT1</u>	C17	Bidirectional (Optional: Open-drain)
PB30 SPICLK <u>RSTR2</u>	C19	Bidirectional (Optional: Open-drain)
PB29 SPIMOSI	E16	Bidirectional (Optional: Open-drain)
PB28 SPIMISO BRGO4	D19	Bidirectional (Optional: Open-drain)
PB27 I2CSDA BRGO1	E19	Bidirectional (Optional: Open-drain)
PB26 I2CSCL BRGO2	F19	Bidirectional (Optional: Open-drain)
PB25 RXADDR3 ² SMTXD1	J16	Bidirectional (Optional: Open-drain)
PB24 TXADDR3 ² SMRXD1	J18	Bidirectional (Optional: Open-drain)
PB23 TXADDR2 ² <u>SDACK1</u> <u>SMSYN1</u>	K17	Bidirectional (Optional: Open-drain)
PB22 TXADDR4 ² <u>SDACK2</u> <u>SMSYN2</u>	L19	Bidirectional (Optional: Open-drain)

Table 35. Pin Assignments (continued)

Name	Pin Number	Type
PB21 SMTXD2 L1CLKOB PHSEL1 ¹ TXADDR1 ²	K16	Bidirectional (Optional: Open-drain)
PB20 SMRXD2 L1CLKOA PHSEL0 ¹ TXADDR0 ²	L16	Bidirectional (Optional: Open-drain)
PB19 <u>RTS1</u> L1ST1	N19	Bidirectional (Optional: Open-drain)
PB18 RXADDR4 ² <u>RTS2</u> L1ST2	N17	Bidirectional (Optional: Open-drain)
PB17 <u>L1RQb</u> L1ST3 <u>RTS3</u> PHREQ1 ¹ RXADDR1 ²	P18	Bidirectional (Optional: Open-drain)
PB16 <u>L1RQa</u> L1ST4 <u>RTS4</u> PHREQ0 ¹ RXADDR0 ²	N16	Bidirectional (Optional: Open-drain)
PB15 BRGO3 TxClav	R17	Bidirectional
PB14 RXADDR2 ² <u>RSTRT1</u>	U18	Bidirectional
PC15 <u>DREQ0</u> <u>RTS1</u> L1ST1 RxClav	D16	Bidirectional
PC14 <u>DREQ1</u> <u>RTS2</u> L1ST2	D18	Bidirectional

Table 35. Pin Assignments (continued)

Name	Pin Number	Type
PC13 L1RQb L1ST3 RTS3	E18	Bidirectional
PC12 L1RQa L1ST4 RTS4	F18	Bidirectional
PC11 CTS1	J19	Bidirectional
PC10 CD1 TGATE1	K19	Bidirectional
PC9 CTS2	L18	Bidirectional
PC8 CD2 TGATE2	M18	Bidirectional
PC7 CTS3 L1TSYNCB SDACK2	M16	Bidirectional
PC6 CD3 L1RSYNCB	R19	Bidirectional
PC5 CTS4 L1TSYNCA SDACK1	T18	Bidirectional
PC4 CD4 L1RSYNCA	T17	Bidirectional
PD15 L1TSYNCA MII-RXD3 UTPB0	U17	Bidirectional
PD14 L1RSYNCA MII-RXD2 UTPB1	V19	Bidirectional
PD13 L1TSYNCB MII-RXD1 UTPB2	V18	Bidirectional

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